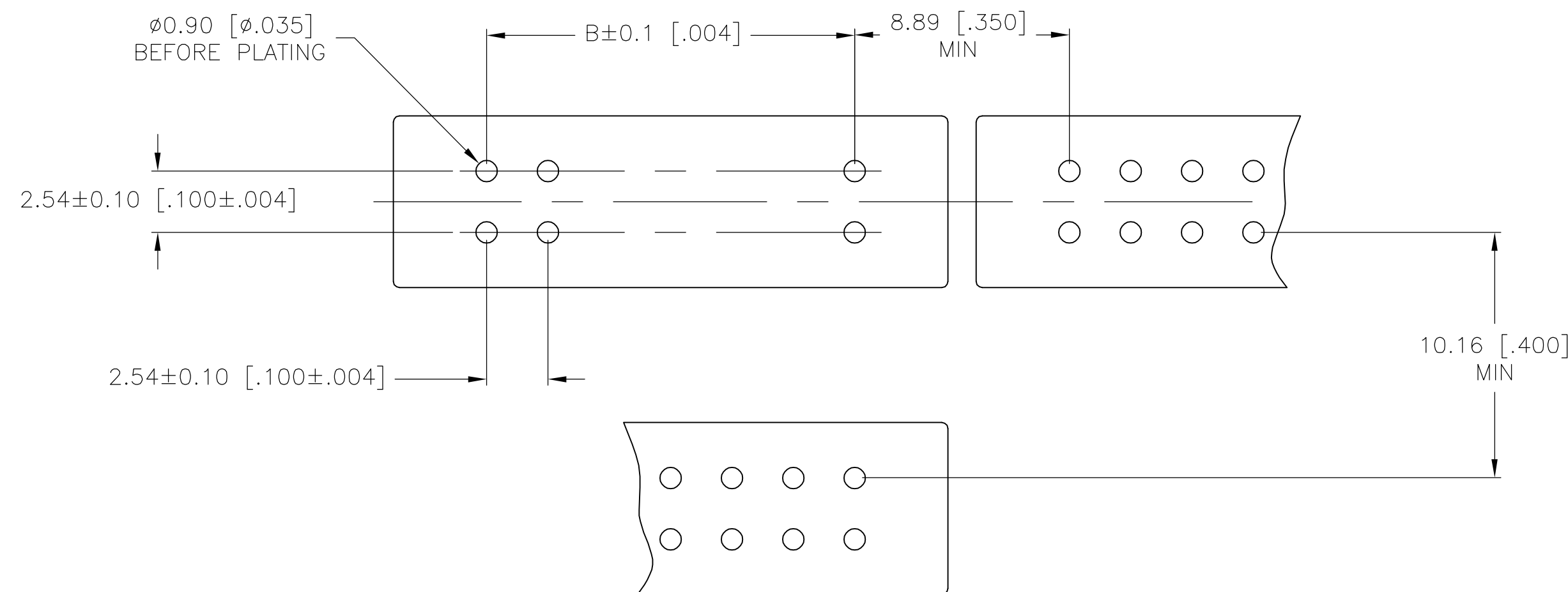
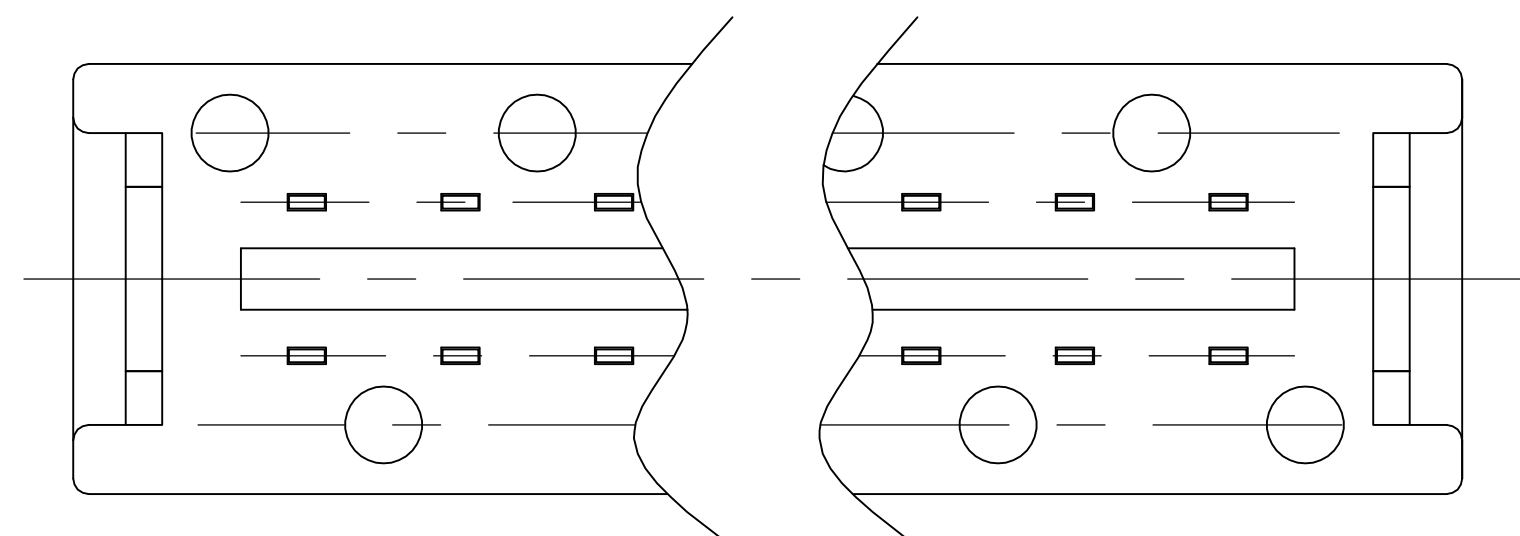
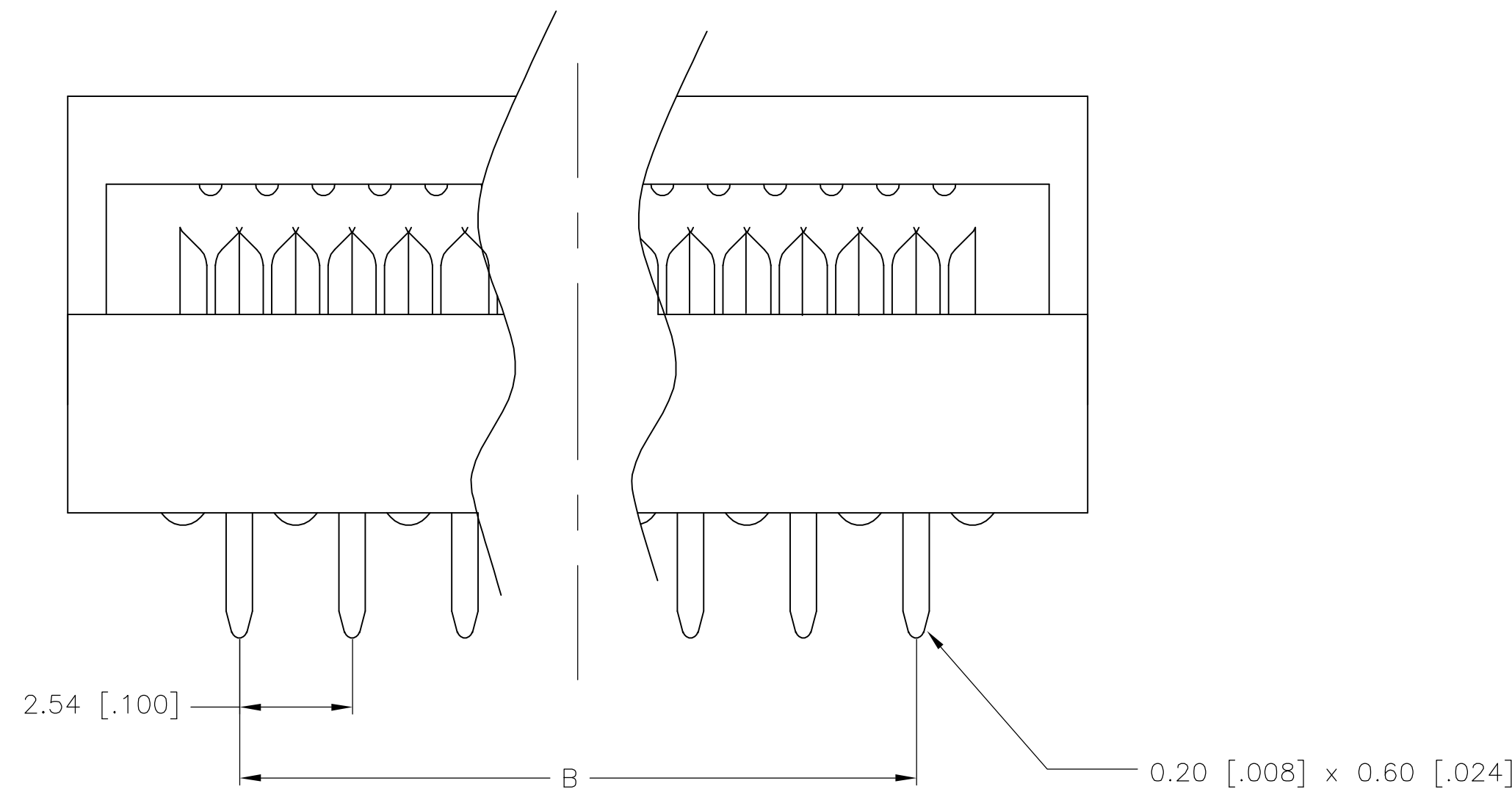
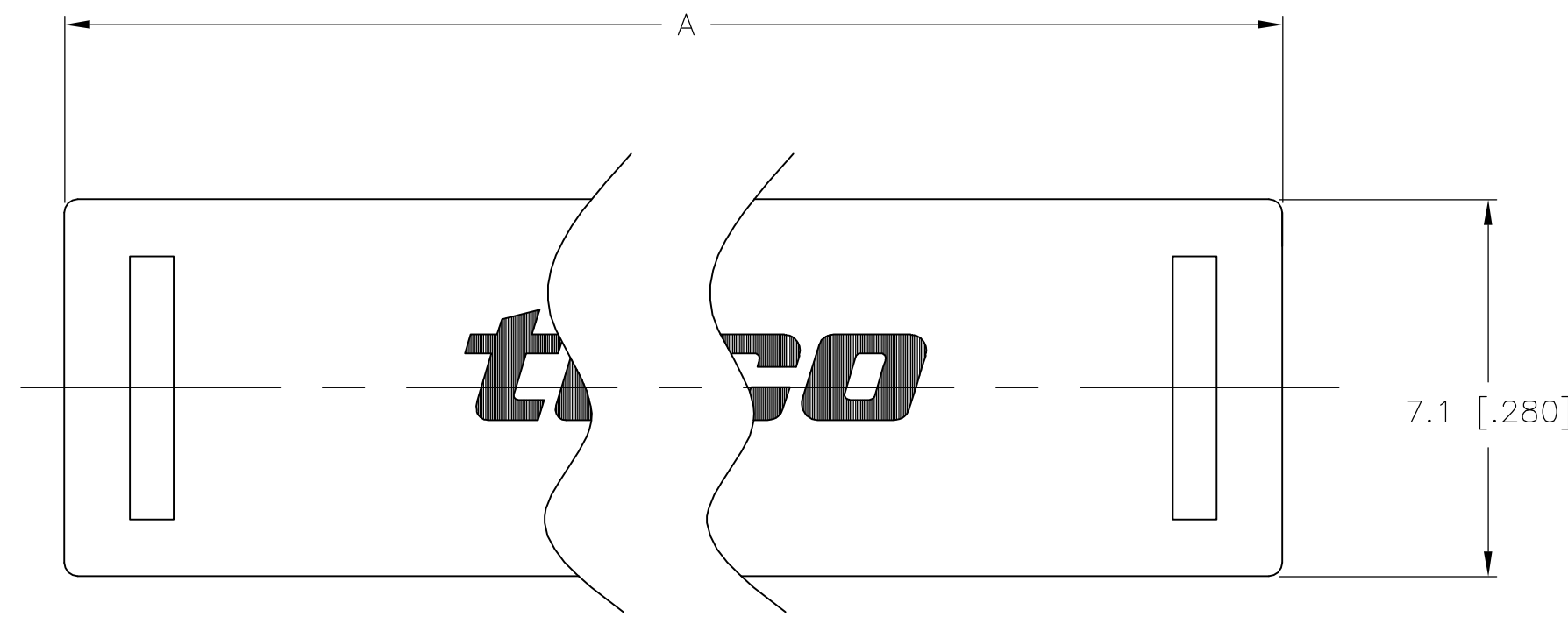
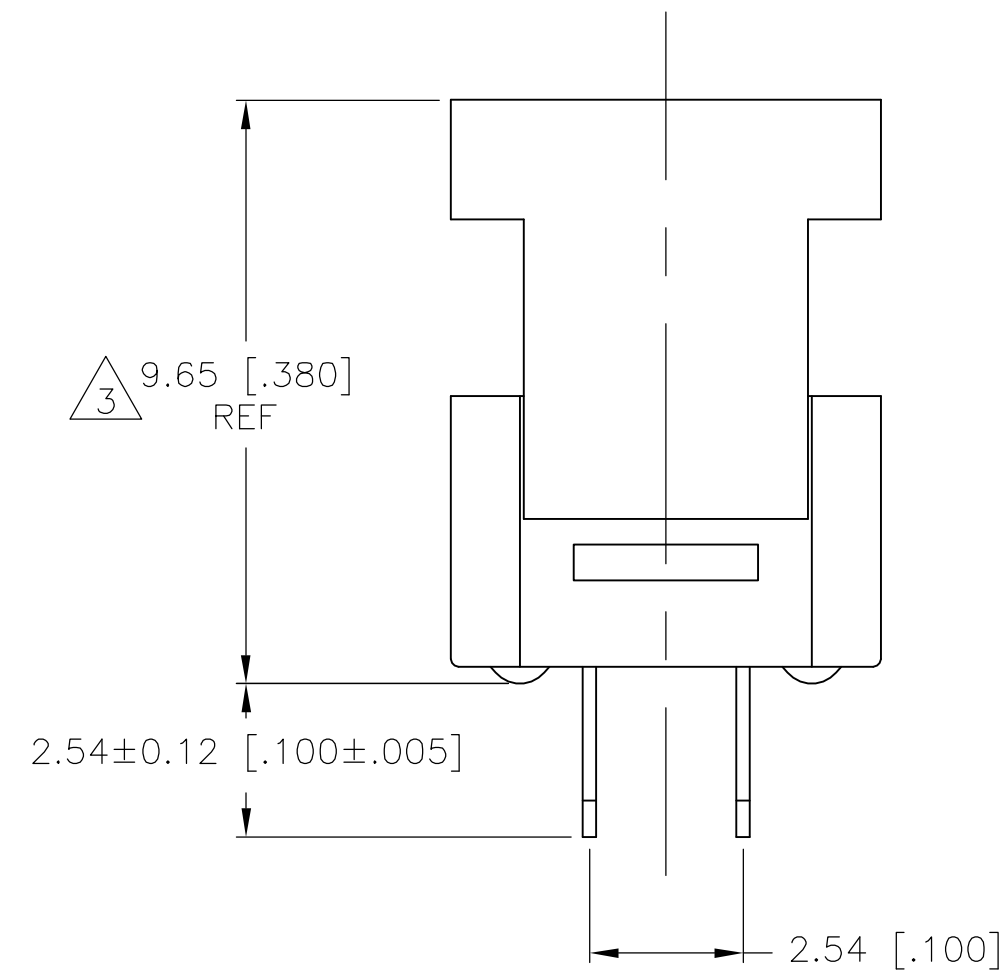


LOC	DIST	REVISIONS					
GP	00	P	LTR	DESCRIPTION	DATE	DWN	APVD
			01	REVISED PER ECO-07-001862	30JAN07	BM	CR



RECOMMENDED PC BOARD LAYOUT
SCALE 5:1



- ① MATERIAL:
HOUSING AND COVER: GLASS-REINFORCED POLYESTER, UL 94-VO, BLUE.
CONTACT: BERYLLIUM COPPER.
- ② FINISH:
CONTACT: 3 μ m [.000118] MIN TIN OVER 1.27 μ m [.000050] MIN NICKEL.
- ③ HEIGHT AFTER CRIMPING = 7.6 $\pm$ 0.25(.301 $\pm$.010).

ELECTRICAL PROPERTIES	
CURRENT RATING	1 AMP
INSULATION RESISTANCE	1×10^8 OHMS @ 500 VDC
DWV:	>500 VOLTS RMS AT SEA LEVEL
ENVIRONMENTAL PROPERTIES	
TEMPERATURE RATING	-55°C TO +125°C

OBSOLETE	78.74	[.3.100]	86.66	[.3.412]	64	609—6453	3—1437006—9
OBSOLETE	73.66	[.2.900]	81.58	[.3.212]	60	609—6053	3—1437006—8
OBSOLETE	60.96	[.2.400]	68.88	[.2.712]	50	609—5053	3—1437006—3
OBSOLETE	48.26	[.1.900]	56.18	[.2.212]	40	609—4053	2—1437006—8
	40.64	[.1.600]	48.56	[.1.912]	34	609—3453	2—1437006—4
	30.48	[.1.200]	38.40	[.1.512]	26	609—2653	2—1437006—1
OBSOLETE	27.94	[.1.100]	35.86	[.1.412]	24	609—2453	1—1437006—7
	22.86	[.900]	30.78	[.1.212]	20	609—2053	1—1437006—6
	17.78	[.700]	25.70	[.1.012]	16	609—1653	1—1437006—3
	15.24	[.600]	23.16	[.912]	14	609—1453	1—1437006—0
	10.16	[.400]	18.08	[.712]	10	609—1053	1437006—7
	5.08	[.200]	13.00	[.512]	6	609—0653	1437006—4
	B		A		NO OF POSN	T&B P/N REF	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN J. POLIGNONE		050CT06		tyco Electronics		Tyco Electronics Corporation Harrisburg, PA 17105-3608	
DIMENSIONS: mm [INCHES]		TOLERANCES, UNLESS OTHERWISE SPECIFIED:		CHK C. ROHDE		050CT06		NAME	
		0 PL/C ± .		APPRO C. ROHDE		PRODUCT SPEC		CONNECTOR ASSEMBLY PCB SOLDER TRANSITION, SLIMLINE	
		1 PL/C ± .		APPLICATION SPEC		SIZE CASE CODE DRAWING NO			
		2 PL/C ± .005		WEIGHT		RESTRICTED TO			
MATERIAL		FINISH		ANGLES ± .2°		A1 00779 C= 1437006-4		—	
1		2		CUSTOMER DRAWING		SCALE 8:1		SHEET 1 of 1 REV 01	